IFX's latest generation of Automotive Power MOSFETs

Infineon Automotive May 2015





Benchmark for Compact Automotive Power MOSFET Design

S308 Package Features:

- Low Package Resistance for lowest R_{DSon}
- High Current Capability up to 40A
- Minimized Footprint Area and Height
- Reduced Package Inductances & Package Parasitics
- Improved Electro Migration / Solder Contact Area





Benchmark for Compact Automotive Power MOSFET Design

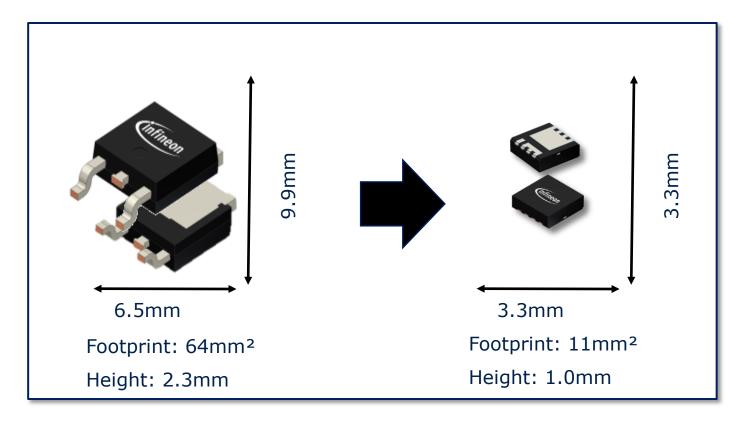
OptiMOS 5 40V Best in Class: IPZ40N04S5L-2R8

- \blacksquare $V_{BRDSS} = 40V$
- \blacksquare R_{DSon (max)} = 2.8mOhm
- $I_D = 40A$
- $R_{th1C} = 2.1 \text{K/W}$
- Package Footprint Area = 11 mm²
- AOI capability for automated optical inspection
- 100% lead-free
- AEC-Q101 qualified
- JEDEC registered





Benchmark for Compact Automotive Power MOSFET Design



~80%
Footprint
Reduction

~50% Height Reduction



~90% Volume Reduction



Benchmark for Compact Automotive Power MOSFET Design



Product Name	max R _{DSon} [mOhm]	I _D [A]	LL/NL	R _{thJC} [K/W]	Status
IPZ40N04S5L-2R8	2.8	40	LL	2.1	Released
IPZ40N04S5-3R1	3.1	40	NL	2.1	Released
IPZ40N04S5L-4R8	4.8	40	LL	3.1	Released
IPZ40N04S5-5R4	5.4	40	NL	3.1	Released
IPZ40N04S5L-7R4	7.4	40	LL	4.4	Released
IPZ40N04S5-8R4	8.4	40	NL	4.4	Released



ENERGY EFFICIENCY MOBILITY SECURITY

Innovative semiconductor solutions for energy efficiency, mobility and security.





